

RESIN MOLDING DEVICE AND METHOD FOR MANUFACTURING RESIN MOLDED
ARTICLE

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ABSTRACT

Provided are: a resin molding device that can suppress warping of a resin molded article while suppressing bad effects on the resin molded article; and a method for manufacturing a resin molded article. This resin molding device is configured to perform resin molding of a subject to be molded, by using a thermosetting resin. This resin molding device comprises a molding mold, a
10 mold-clamping mechanism, and a temperature adjustment mechanism. The mold-clamping mechanism is configured to clamp the molding mold. The temperature adjustment mechanism is configured to adjust the temperature of the molding mold. The temperature adjustment mechanism is configured to heat the molding mold in a completely clamped state during resin
15 resin molding.

FIG. 6